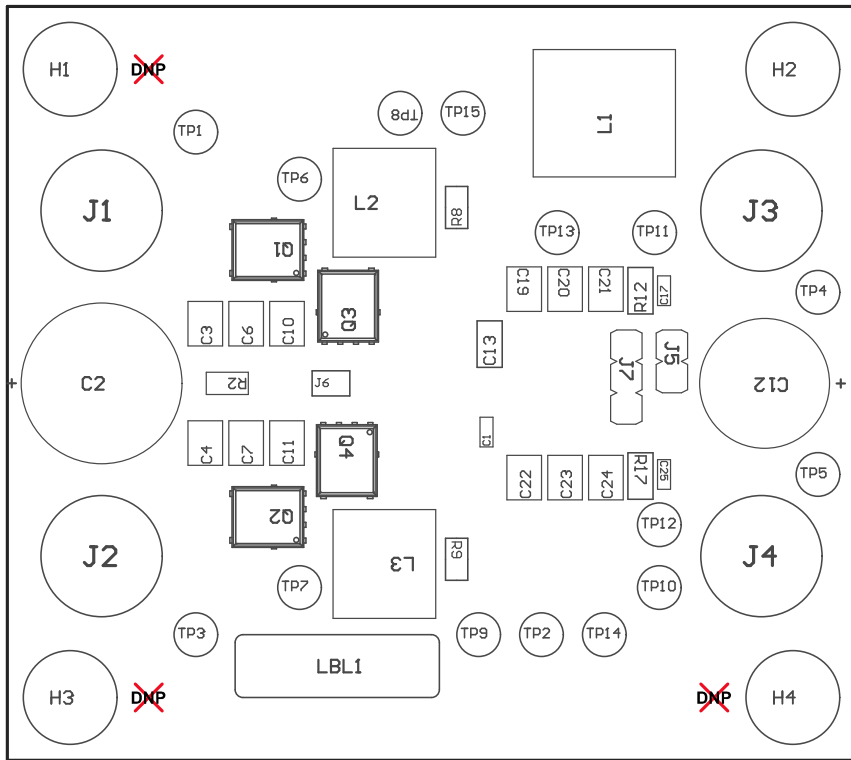


ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■These assemblies are ESD sensitive, ESD precautions shall be observed.

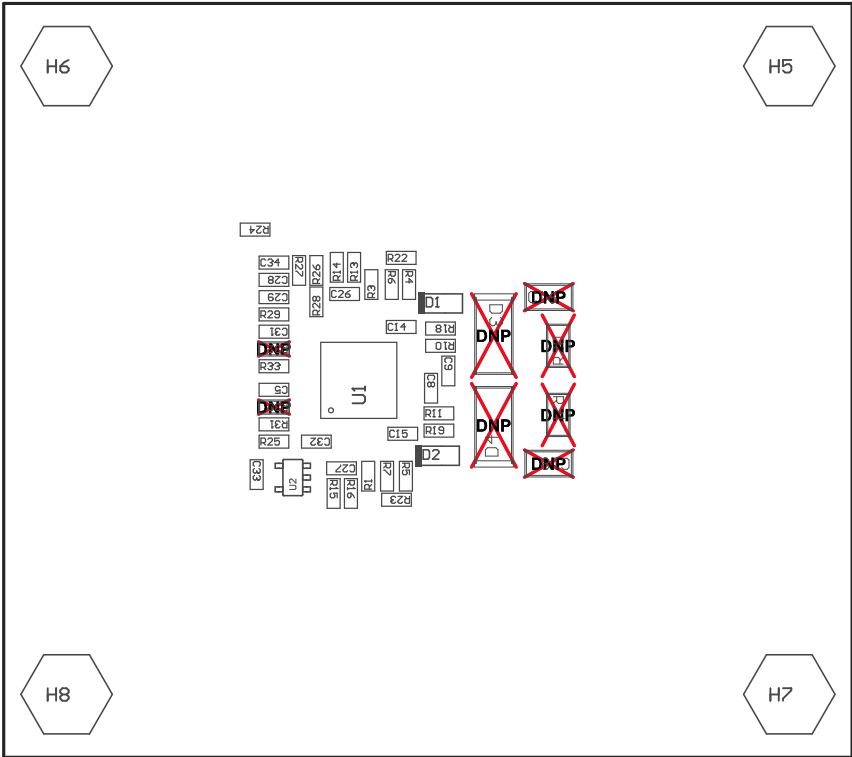
ZZ3 ■These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 ■These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

|                                  |                                   |                   |                                |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE         | BOARD #: PMP20440                 | REV: A            | SVN REV: Not In VersionControl |
|                                  | TID #: PMP20440                   |                   |                                |
| PLOT NAME = Top Assembly Drawing | GENERATED : 9/23/2016 12:15:45 PM | TEXAS INSTRUMENTS |                                |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

|                                     |                                   |        |                                |
|-------------------------------------|-----------------------------------|--------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE         | BOARD #: PMP20440                 | REV: A | SUN REV: Not In VersionControl |
|                                     | TID #: PMP20440                   |        |                                |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 9/23/2016 12:15:46 PM |        | TEXAS INSTRUMENTS              |

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